

HD74LV1G08A

2-input AND Gate

REJ03D0066-0700Z (Previous ADE-205-319E (Z)) Rev.7.00 Aug.29.2003

Description

The HD74LV1G08A has two-input AND gate in a 5 pin package. Low voltage and high-speed operation is suitable for the battery powered products (e.g., notebook computers), and the low power consumption extends the battery life.

Features

- The basic gate function is lined up as Renesas uni logic series.
- Supplied on emboss taping for high-speed automatic mounting.
- Electrical characteristics equivalent to the HD74LV08A

Supply voltage range: 1.65 to 5.5 V

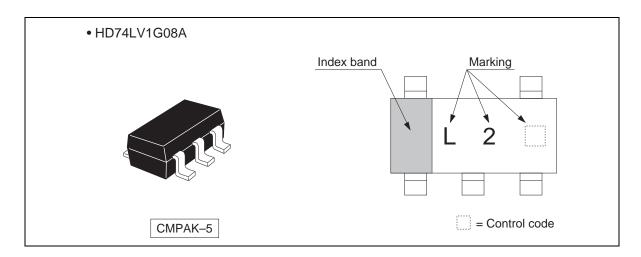
Operating temperature range: -40 to +85°C

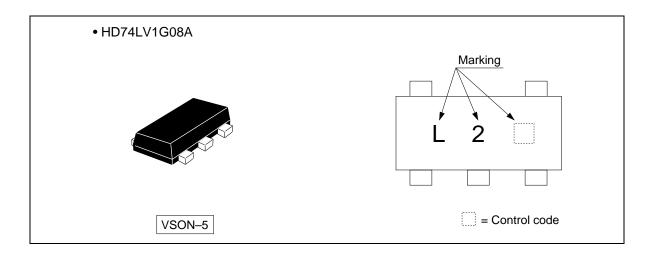
- All inputs V_{IH} (Max.) = 5.5 V (@ V_{CC} = 0 V to 5.5 V)
 - All outputs V_0 (Max.) = 5.5 V (@V_{CC} = 0 V)
- Output current ± 6 mA (@V_{CC} = 3.0 V to 3.6 V), ± 12 mA (@V_{CC} = 4.5 V to 5.5 V)
- All the logical input has hysteresis voltage for the slow transition.
- Ordering Information

Part Name	Package Type	Package Code	Package Abbreviation	Taping Abbreviation (Quantity)
HD74LV1G08ACME	CMPAK-5 pin	CMPAK-5V	СМ	E (3,000 pcs/reel)
		CMPAK-5V(O)	_	
HD74LV1G08AVSE	VSON-5 pin	TNP-5DV	VS	_

Note: Please consult the sales office for the above package availability.

Outline and Article Indication



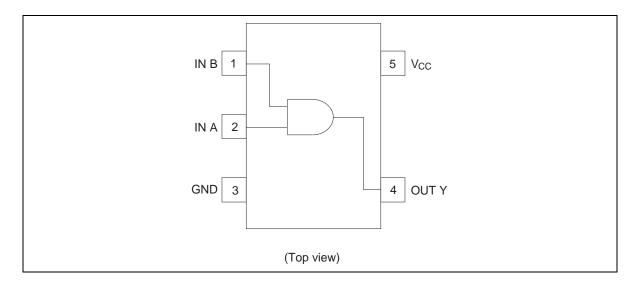


Function Table

Inputs		Output Y	
A	В		
L	L	L	
Н	L	L	
L	Н	L	
Н	Н	Н	

H : High level L : Low level

Pin Arrangement



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Test Conditions
Supply voltage range	V _{CC}	-0.5 to 7.0	V	
Input voltage range *1	Vı	-0.5 to 7.0	V	
Output voltage range *1, 2	Vo	-0.5 to $V_{CC} + 0.5$	V	Output : H or L
		-0.5 to 7.0	 -	V _{CC} : OFF
Input clamp current	I _{IK}	-20	mA	V _I < 0
Output clamp current	lok	±50	mA	$V_O < 0$ or $V_O > V_{CC}$
Continuous output current	Io	±25	mA	$V_O = 0$ to V_{CC}
Continuous current through V _{CC} or GND	I _{CC} or I _{GND}	±50	mA	
Maximum power dissipation at Ta = 25°C (in still air) *3	P _T	200	mW	
Storage temperature	Tstg	-65 to 150	°C	

Notes: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore no two of which may be realized at the same time.

- 1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
- 2. This value is limited to 5.5 V maximum.
- 3. The maximum package power dissipation was calculated using a junction temperature of 150°C.

HD74LV1G08A

Recommended Operating Conditions

Item	Symbol	Min	Max	Unit	Conditions
Supply voltage range	V _{CC}	1.65	5.5	V	
Input voltage range	VI	0	5.5	V	
Output voltage range	Vo	0	Vcc	V	
Output current	I _{OL}	_	1	mA	$V_{CC} = 1.65 \text{ to } 1.95 \text{ V}$
		_	2		$V_{CC} = 2.3 \text{ to } 2.7 \text{ V}$
		_	6		$V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$
		_	12		$V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$
	I _{OH}	_	-1		V_{CC} = 1.65 to 1.95 V
		_	-2		$V_{CC} = 2.3 \text{ to } 2.7 \text{ V}$
		_	-6		$V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$
		_	-12		$V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$
Input transition rise or fall rate	Δt / Δν	0	300	ns / V	V _{CC} = 1.65 to 1.95 V
		0	200		$V_{CC} = 2.3 \text{ to } 2.7 \text{ V}$
		0	100		$V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$
		0	20		$V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$
Operating free-air temperature	Ta	-40	85	°C	

Note: Unused or floating inputs must be held high or low.

Electrical Characteristic

• $Ta = -40 \text{ to } 85^{\circ}C$

Item	Symbol	V _{CC} (V) *	Min	Тур	Max	Unit	Test condition
Input voltage	V _{IH}	1.65 to 1.95	V _{CC} ×0.75	_	_	V	
		2.3 to 2.7	V _{CC} ×0.7	_	_	=	
		3.0 to 3.6	V _{CC} ×0.7	_	_	-	
		4.5 to 5.5	V _{CC} ×0.7	_	_	-	
	V_{IL}	1.65 to 1.95	_	_	V _{CC} ×0.25	-	
		2.3 to 2.7	_	_	V _{CC} ×0.3	=	
		3.0 to 3.6	_	_	V _{CC} ×0.3	-	
		4.5 to 5.5	_	_	V _{CC} ×0.3	-	
Hysteresis voltage	V _H	1.8	_	0.25	_	V	$V_T^+ - V_T^-$
		2.5	_	0.30	_	-	
		3.3	_	0.35	_	=	
		5.0	_	0.45	_	=	
Output voltage	V_{OH}	Min to Max	V _{CC} -0.1	_	_	V	$I_{OH} = -50 \mu A$
		1.65	1.4	_	_	-	$I_{OH} = -1 \text{ mA}$
		2.3	2.0	_	_	-	$I_{OH} = -2 \text{ mA}$
		3.0	2.48	_	_	-	$I_{OH} = -6 \text{ mA}$
		4.5	3.8	_	_	=	$I_{OH} = -12 \text{ mA}$
	V _{OL}	Min to Max	_	_	0.1	=	$I_{OL} = 50 \mu A$
		1.65	_	_	0.3	=	I _{OL} = 1 mA
		2.3	_	_	0.4	=	$I_{OL} = 2 \text{ mA}$
		3.0	_	_	0.44	=	I _{OL} = 6 mA
		4.5	_	_	0.55	=	I _{OL} = 12 mA
Input current	I _{IN}	0 to 5.5	_	_	±1	μΑ	$V_{IN} = 5.5 \text{ V or GND}$
Quiescent supply current	Icc	5.5	_	_	10	μΑ	$V_{IN} = V_{CC}$ or GND, $I_O = 0$
Output leakage current	l _{OFF}	0	_	_	5	μА	V_{IN} or $V_O = 0$ to 5.5 V
Input capacitance	C _{IN}	3.3	_	2.5	_	pF	V _{IN} = V _{CC} or GND

Note: For conditions shown as Min or Max, use the appropriate values under recommended operating conditions.

Switching Characteristics

$\bullet \quad V_{CC} = 1.8 \pm 0.15 \ V$

Item	Symbol	Ta = 1	25°C	Ta = -40 to 85°C		Unit		FROM	то	
		Min	Тур	Max	Min	Max		Conditions	(Input)	(Output)
Propagation	t _{PLH}	_	12.8	22.7	1.0	25.0	ns	C _L = 15 pF	A or B	Υ
delay time	t _{PHL}	_	19.4	32.8	1.0	38.5	_	$C_L = 50 pF$		

$\bullet \quad V_{CC} = 2.5 \pm 0.2 \ V$

Item	Symbol	Ta = 2	25°C		Ta = -	40 to 85°C	Unit		FROM	то
		Min	Тур	Max	Min	Max	_	Conditions	(Input)	(Output)
Propagation	t _{PLH}	_	7.9	13.8	1.0	16.0	ns	C _L = 15 pF	A or B	Υ
delay time	t _{PHL}	_	10.5	17.3	1.0	20.0	_	C _L = 50 pF	_	

$\bullet \quad V_{CC} = 3.3 \pm 0.3 \ V$

Item	Symbol	Ta = 2	25°C	5° C Ta = -40 to 85°C		Unit		FROM	TO	
		Min	Тур	Max	Min	Max	_	Conditions	(Input)	(Output)
Propagation	t _{PLH}	_	5.6	8.8	1.0	10.5	ns	C _L = 15 pF	A or B	Υ
delay time	t _{PHL}	_	7.5	12.3	1.0	14.0	-	C _L = 50 pF	_	

$\bullet \quad V_{CC} = 5.0 \pm 0.5 \ V$

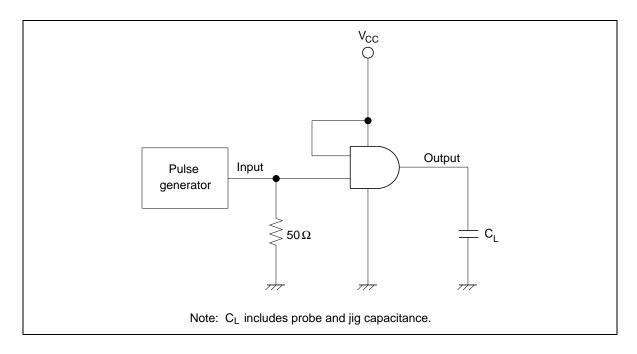
Item	Symbol	Ta = 2	25°C	°C Ta = -40 to 85 °C		Unit		FROM	ТО	
		Min	Тур	Max	Min	Max	_	Conditions	(Input)	(Output)
Propagation	t _{PLH}	_	4.1	5.9	1.0	7.0	ns	C _L = 15 pF	A or B	Υ
delay time	t _{PHL}	_	5.5	7.9	1.0	9.0	_	C _L = 50 pF	_	

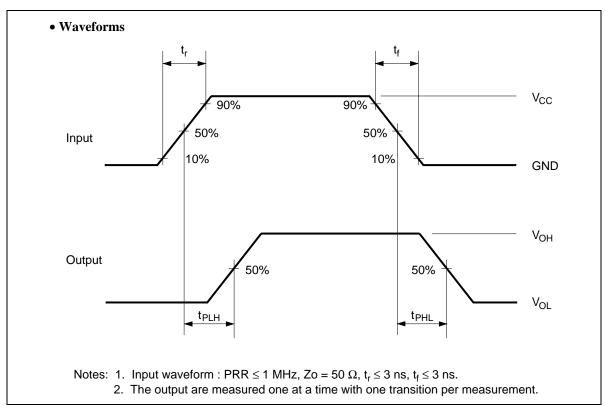
Operating Characteristics

• $C_L = 50 \text{ pF}$

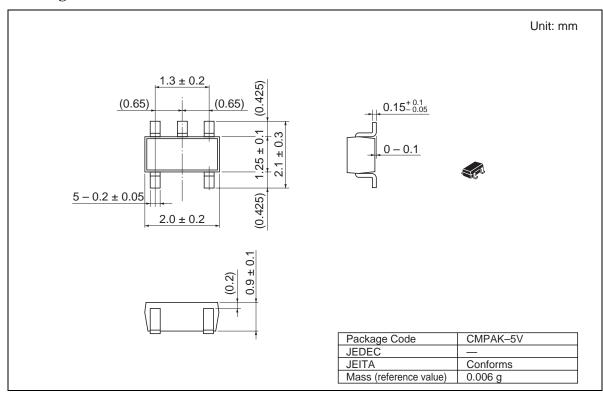
Item	Symbol	V _{CC} (V)	Ta = 2	Ta = 25°C			Test Conditions
			Min	Тур	Max	<u> </u>	
Power dissipation	C_{PD}	3.3	_	8.0	_	pF	f = 10 MHz
capacitance		5.0		10.0	_		

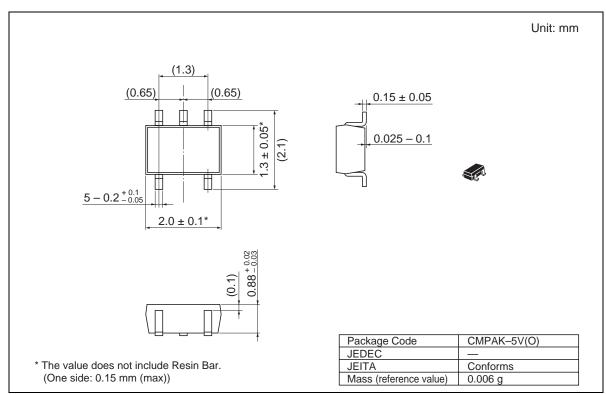
Test Circuit

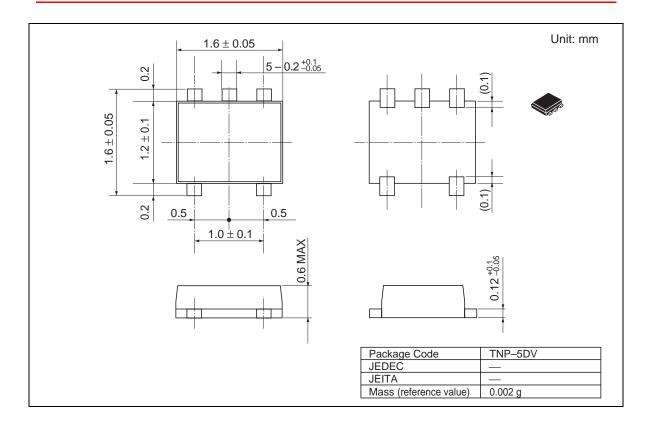




Package Dimensions







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